BT169 series

GENERAL DESCRIPTION

Glass passivated, sensitive gate thyristors in a plastic envelope, intended for use in general purpose switching and phase control applications. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

QUICK REFERENCE DATA

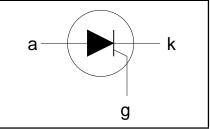
SYMBOL	PARAMETER	MAX.	MAX.	MAX.	MAX.	UNIT
V _{DRM} ,	BT169 Repetitive peak off-state voltages	B 200	D 400	E 500	G 600	V
V _{RRM} I _{T(AV)}	Average on-state	0.5	0.5	0.5	0.5	А
I _{T(RMS)} I _{TSM}	RMS on-state current Non-repetitive peak on-state current	0.8 8	0.8 8	0.8 8	0.8 8	A A

PINNING - TO92 variant

PIN	DESCRIPTION	
1	anode	
2	gate	
3	cathode	

PIN CONFIGURATION

SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.		M	AX.		UNIT
V_{drm}, V_{rrm}	Repetitive peak off-state voltages		-	B 200 ¹	D 400 ¹	E 500 ¹	G 600 ¹	V
$I_{T(AV)}$	Average on-state current	half sine wave; T _{lead} ≤ 83 °C	-		0	.5		A
I _{T(RMS)} I _{TSM}	RMS on-state current Non-repetitive peak on-state current	all conduction angles t = 10 ms t = 8.3 ms half sine wave; $T_j = 125 \ ^{\circ}C$ prior to surge; with reapplied	- -			.8 8 9		A A A
l²t dl _⊤ /dt	I ² t for fusing Repetitive rate of rise of on-state current after triggering	$V_{DRM(max)}$ t = 10 ms I _{TM} = 2 A; I _G = 10 mA; dI _G /dt = 100 mA/µs	-			32 50		A²s A/µs
$I_{GM} \\ V_{RGM} \\ P_{GM} \\ P_{G(AV)} \\ T_{stg} \\ T_{j}$	Peak gate current Peak gate voltage Peak reverse gate voltage Peak gate power Average gate power Storage temperature Operating junction temperature	over any 20 ms period	- - - -40 -		0 1	1 5 2 .1 50 25		°°°°€≤

¹ Although not recommended, off-state voltages up to 800V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 $A/\mu s$.

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-lead}	Thermal resistance junction to lead		-	-	60	K/W
R _{th j-a}	Thermal resistance junction to ambient	pcb mounted; lead length = 4mm	-	150	-	K/W

STATIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

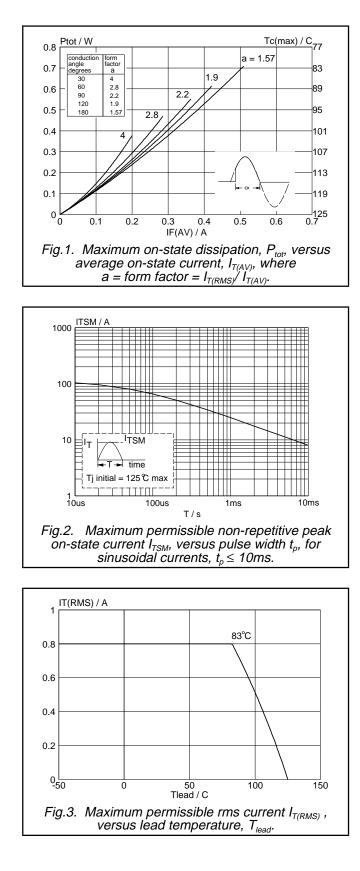
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{GT} I _L I _H V _T	Gate trigger current Latching current Holding current On-state voltage		- - -	50 2 2 1.2	200 6 5 1.35	μA mA mA V
V _{GT}	Gate trigger voltage	\dot{V}_{D} = 12 V; I _T = 10 mA; gate open circuit V_{D} = $V_{DRM(max)}$; I _T = 10 mA; T _j = 125 °C; gate open circuit	0.2	0.5 0.3	0.8 -	V V
I _D , I _R	Off-state leakage current	$V_{D} = V_{DRM(max)}; V_{R} = V_{RRM(max)}; T_{j} = 125 \text{ °C}; R_{GK} = 1 k\Omega$	-	0.05	0.1	mA

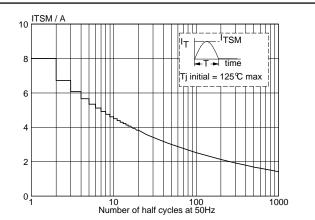
DYNAMIC CHARACTERISTICS

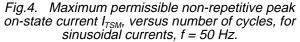
 $T_j = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
dV _D /dt	Critical rate of rise of off-state voltage	$V_{DM} = 67\% V_{DRM(max)}; T_j = 125 °C;$ exponential waveform; $R_{GK} = 1 k\Omega$	-	25	-	V/µs
t _{gt}	Gate controlled turn-on time	$I_{TM} = 2 \text{ A}; V_D = V_{DRM(max)}; I_G = 10 \text{ mA};$ $dI_C/dt = 0.1 \text{ A/us}$	-	2	-	μs
t _q	Circuit commutated turn-off time	$V_{D}^{"} = 67\% V_{DRM(max)}; T_{i} = 125 °C;$ $I_{TM} = 1.6 A; V_{R} = 35 V; dI_{TM}/dt = 30 A/\mu s;$ $dV_{D}/dt = 2 V/\mu s; R_{GK} = 1 k\Omega$	-	100	-	μs

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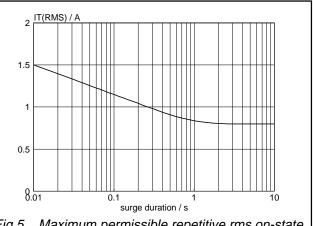
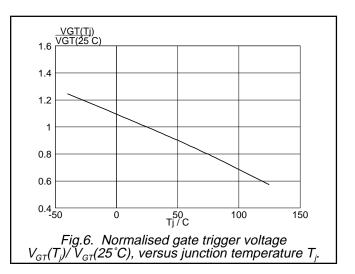
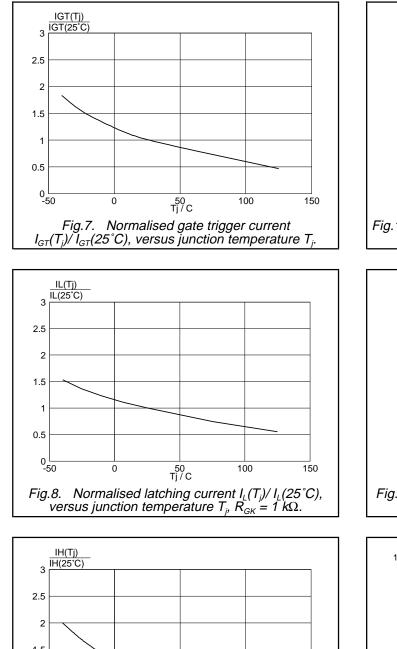
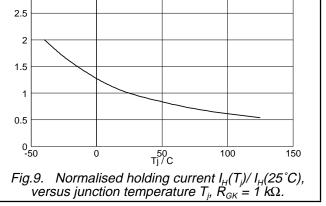


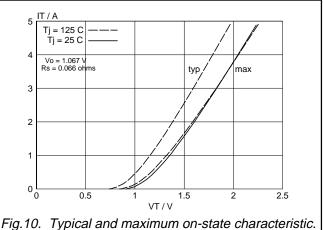
Fig.5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, f = 50 Hz; $T_{lead} \le 83$ °C.

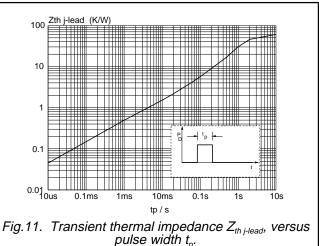


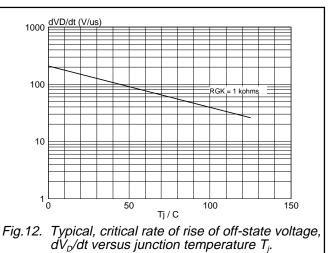
BT169 series







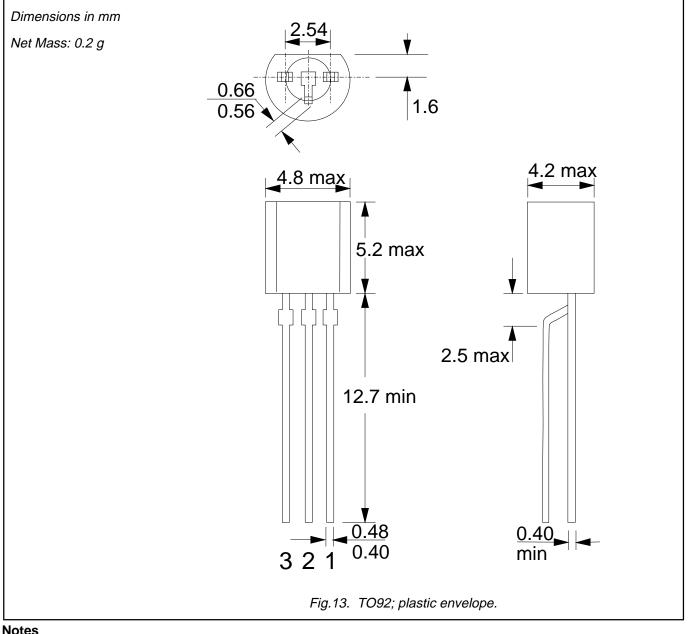




Product specification

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MECHANICAL DATA



Notes 1. Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

Data sheet status					
Objective specification	pjective specification This data sheet contains target or goal specifications for product development.				
Preliminary specification	Preliminary specification This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	This data sheet contains final product specifications.				
Limiting values	Limiting values				
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.					
Application information					

Where application information is given, it is advisory and does not form part of the specification.

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